## **Characteristics**

- High dimension accuracy and flatness
  Formability in high-speed stamping ,photo etching and stability after forming.
- Good surface cleanness and surface uniformity. Excellent surface processability and adhesiveness of oxide film for highspeed plating.
- ·High hardness and transform resistance.
- Much closeness to coefficient of linear expansion of Si, so it is adequate to use 42%Ni-Fe in molding process.
- Precice composition control ensures the stability of product characteristics.
- Referential standards: ASTM F-30(UNS K94100)



## Chemical composition(wt%)

Ni	Fe

41 Bal.

## **Mechanical properties**

Temper	T/S (N/mm²)	Elongation (%)	Hardness (HV)
А	~590	≧ 30	120~160
1/2H	590~735	≧3	180~220

## Physical properties

Density(20°C)	g/cm³	8.15
Modulus of elasticity	GPa	145
Electrical resistivity	μΩ•m	0.55
Thermal conductivity	W/(m•K)	14.7
Coefficient of linear expansion(900 °C × 1hr)	X10 <sup>-6</sup> /°C	4.2(30-300°C)
Curie point	°C	375
Melting point	°C	1425